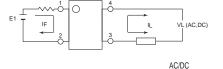
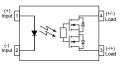
<u>SUPSiC®</u>

1 Form A GAQY221S SOP-4 Load Voltage:60V Load Current:200mA

Parameter	Symbol	Rating	Units
Load Voltage	VL	60	V
Load Current	١L	0.2	А
On-Resistance	Ron	2	Ω
I/O Breakdown Voltage	V/ıo	2500	Vrms







SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

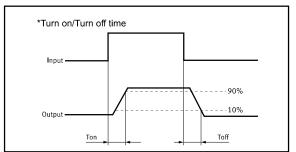
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Catagoni	Output Rating		Deelvere	Part No.	Dealving Quantity	
Category Load	Load Voltage	Load Current	Package	Part NO.	Packing Quantity	
AC/DC	60V	0.2A	SOP-4	GAQY221S	2000pcs /reel	



Absolute Maximum Ratings (Ta = 25°C)

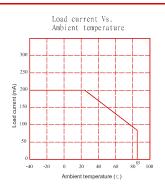
	Item	Symbol	Va l ue	Units	Note
Continuous LED Current		l,	50	mA	
Input	Peak LED Current	IFP	1000	mA	f=100Hz, duty=1%
·	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pin	75	mW	
Output	Load Voltage	VL	60	V(AC peak or DC)	
	Load Current	l.	0.2	А	
	Peak Load Current	Peak	1.0	А	100ms(1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Powe	er Dissipation	Ρτ	500	mW	
I/O Breakd	lown Vo l tage	Vi/o	2500	Vrms	RH=60%, 1min
Operating	Temperature	Topr	-40 to 85	C°	
Storage Te	emperature	Tstg	-40 to 100	°C	
Pin Solder	ing Temperature	Tsol	260	°C	10 sec max.

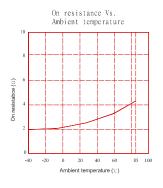
Electrical Characteristics (Ta = 25°C)

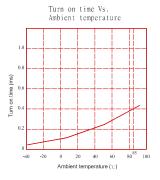
Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.4	V	l⊧=10mA
	Operation LED Current	Fon		0.5	2.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	VFoff	0.5			V	
	On-Resistance	Ron		2	5	Ω	I⊧=5mA,I∟=Max Time to flow is within 1 sec.
Output	Off-State Leakage Current	Leak		0.03	0.1	uA	V₋=Rating
	Output Capacitance	Cout		6		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.15	0.5	ms	l⊧=5mA, l⊾=Max
sion	Turn-Off Time	T _{off}		0.05	0.5	ms	
Ocumbral	I/O Isolation Resistance	Ri⁄o	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

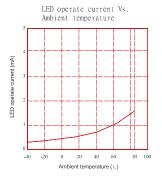
Engineering Data

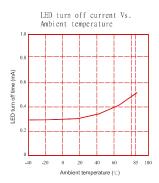






Turn off time Vs. Ambient temperature



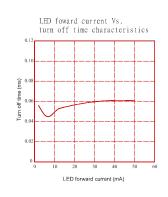


LED forward voltage Vs. Ambient temperature

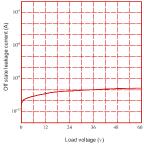
LED foward current Vs. turn on time characteristics



┝┥╸	Current, A 00			
		-20 -40 -60 -80 -100	2 3 4 Voltage,	5 V



Off state leakage current Vs. Load voltage characteristics

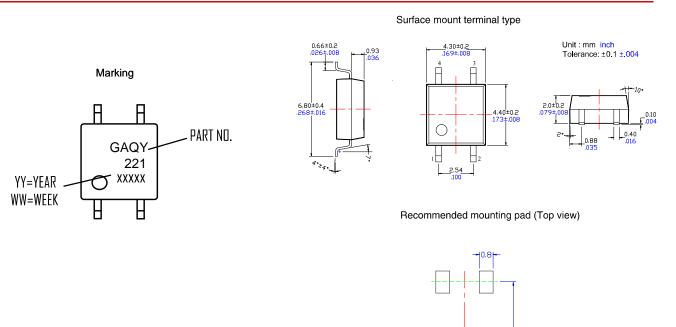


Applied voltage Vs. output capacitance characteristics

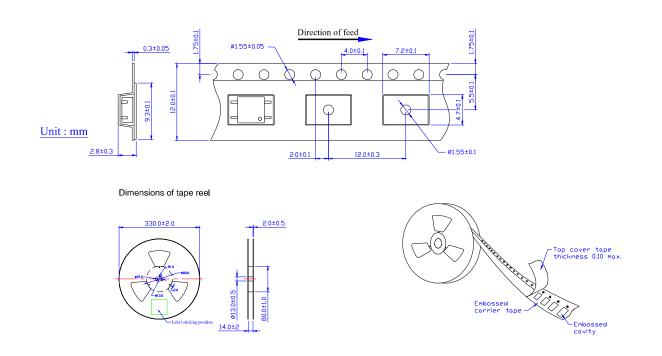
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Unit : mm Tolerance : ±0.1

Dimensions and Package



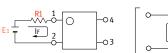
Tape dimensions

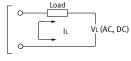




Using Methods

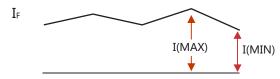
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

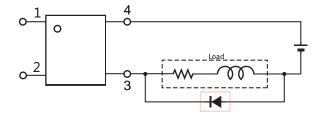
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	١ _F	5.0	7.0	30	mA

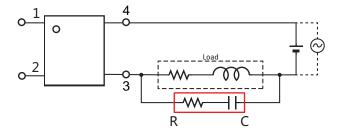
Protection Circuit

Output spike voltages: if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.